

### 3.2mmx1.6mm SMD CHIP LED LAMP

Part Number: APT3216SECK/J3-PRV Hyper Red

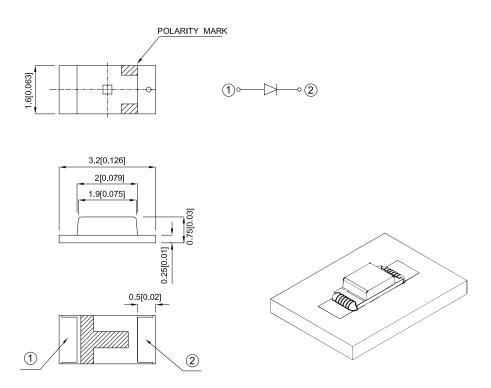
### **Features**

- 3.2mmx1.6mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAN0481 **REV NO: V.2A** DATE: MAR/24/2015 PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: L.Q.Xie ERP: 1203013845

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APT3216SECK/J3-PRV		700	1100	400°	
	Hyper Red (AlGaInP)	Water Clear	*200	*350	120°

### Notes:

- $1. \theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.2	2.8	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	VR=5V

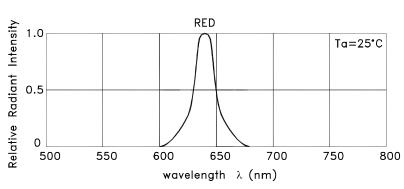
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

### Absolute Maximum Ratings at TA=25°C

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Parameter	Hyper Red	Units			
Power dissipation	84	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

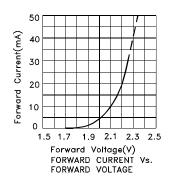
SPEC NO: DSAN0481 **REV NO: V.2A** DATE: MAR/24/2015 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: L.Q.Xie ERP: 1203013845

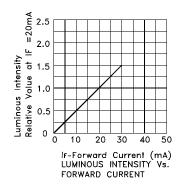


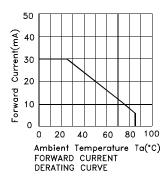
RELATIVE INTENSITY Vs. WAVELENGTH

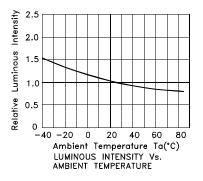
### **Hyper Red**

### APT3216SECK/J3-PRV



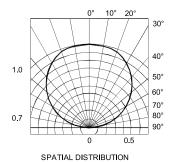






PAGE: 3 OF 5

ERP: 1203013845



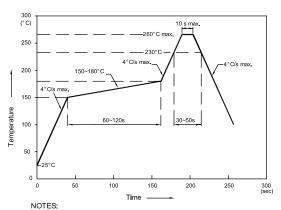
SPEC NO: DSAN0481 REV NO: V.2A DATE: MAR/24/2015

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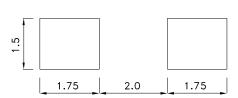
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

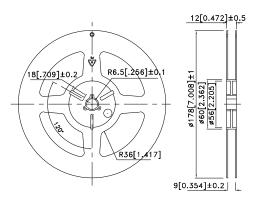


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
  3.Number of reflow process shall be 2 times or less.

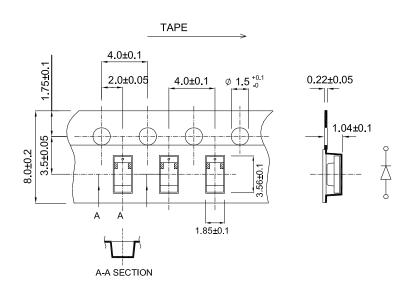
### Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**



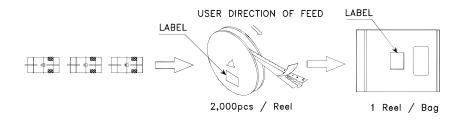
Tape Dimensions (Units : mm)

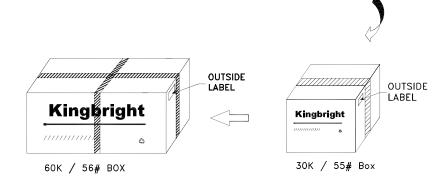


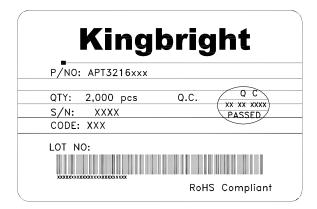
SPEC NO: DSAN0481 APPROVED: WYNEC REV NO: V.2A CHECKED: Allen Liu DATE: MAR/24/2015 DRAWN: L.Q.Xie PAGE: 4 OF 5 ERP: 1203013845

### **PACKING & LABEL SPECIFICATIONS**

### APT3216SECK/J3-PRV







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 SPEC NO: DSAN0481
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 PAGE: 5 OF 5

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